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ABSTRACT OF THE DISCLOSURE

*Sub-A3>* Guide rails for guiding a band-form member such as a film carrier tape in a semiconductor manufacturing apparatus comprising a pair of rail main bodies with a plurality of guide assemblies provided on the upper surfaces of the rail main bodies so that the guide assemblies partially guide the upper surface of the band-form member.

1000 900 800 700 600 500 400 300 200 100